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C

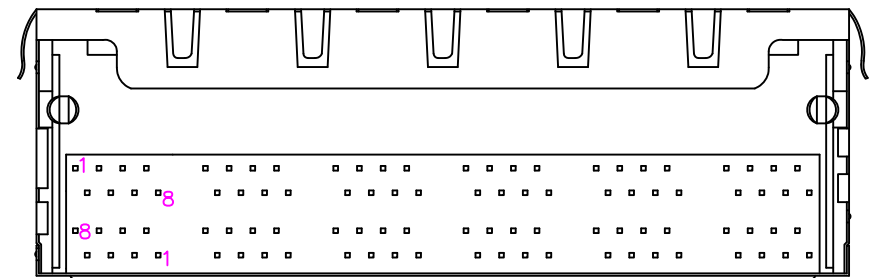
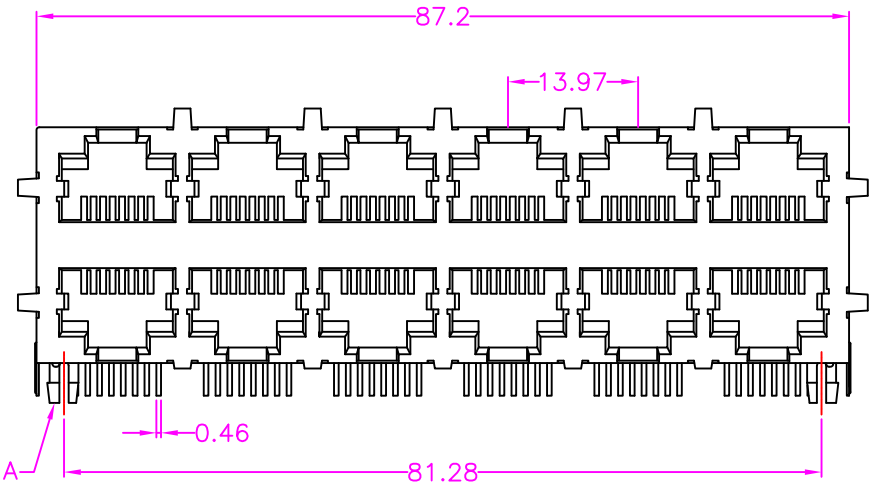
C

B

B

A

A



PART NUMBER:

3MJDD - 2 6 8 8 * - 1 1 6

SERIES

2X6 PORT

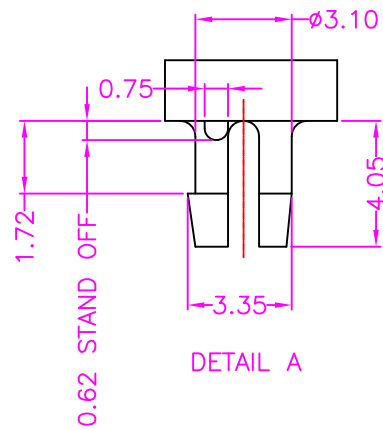
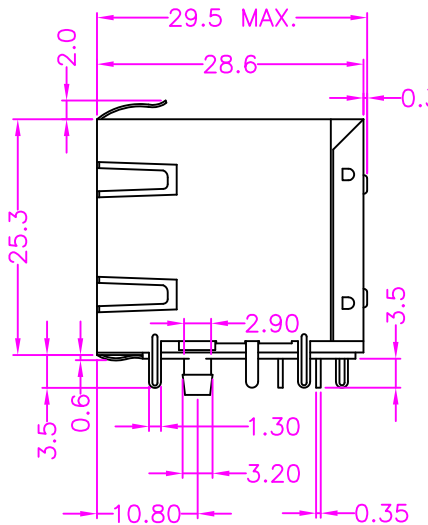
8 POSITION & 8 CONTACT

TRAY PACKAGE

CONTACT PLATED OPTION

- 1: GOLD FLASH
- 3: 3u" GOLD
- 5: 5u" GOLD
- 7: 15u" GOLD
- 9: 30u" GOLD
- 11: 6u" GOLD

A	RELEASE	2014.9.5
REV.	DESCRIPTION	DATE

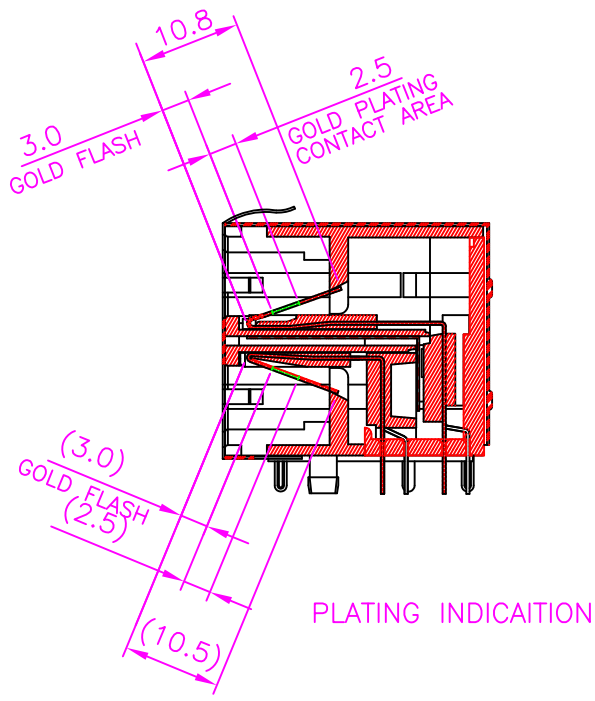


MATERIALS

HOUSING: HI-TEMP. PLASTIC (UL 94V-0)
SHELL: COPPER ALLOY, NICKEL PLATING
TERMINAL: COPPER ALLOY, GOLD PLATED

SPECIFICATION

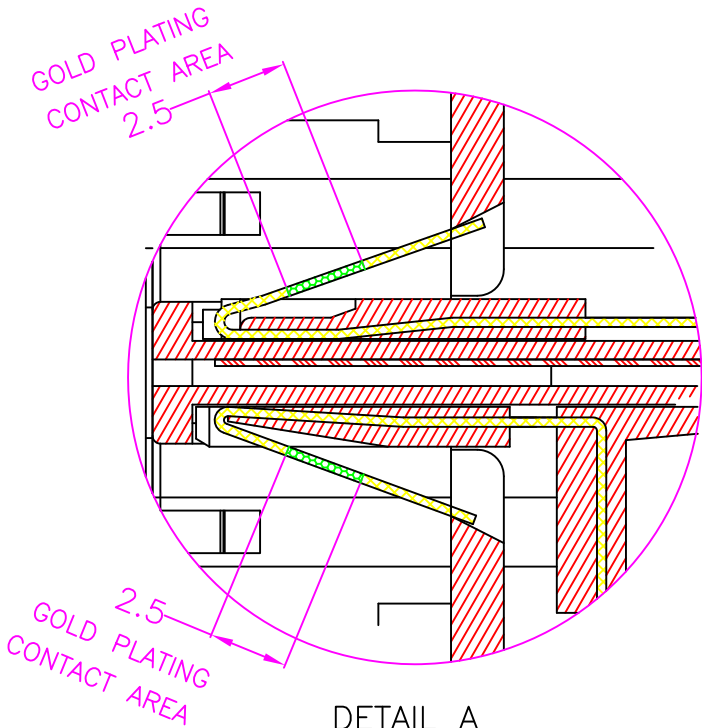
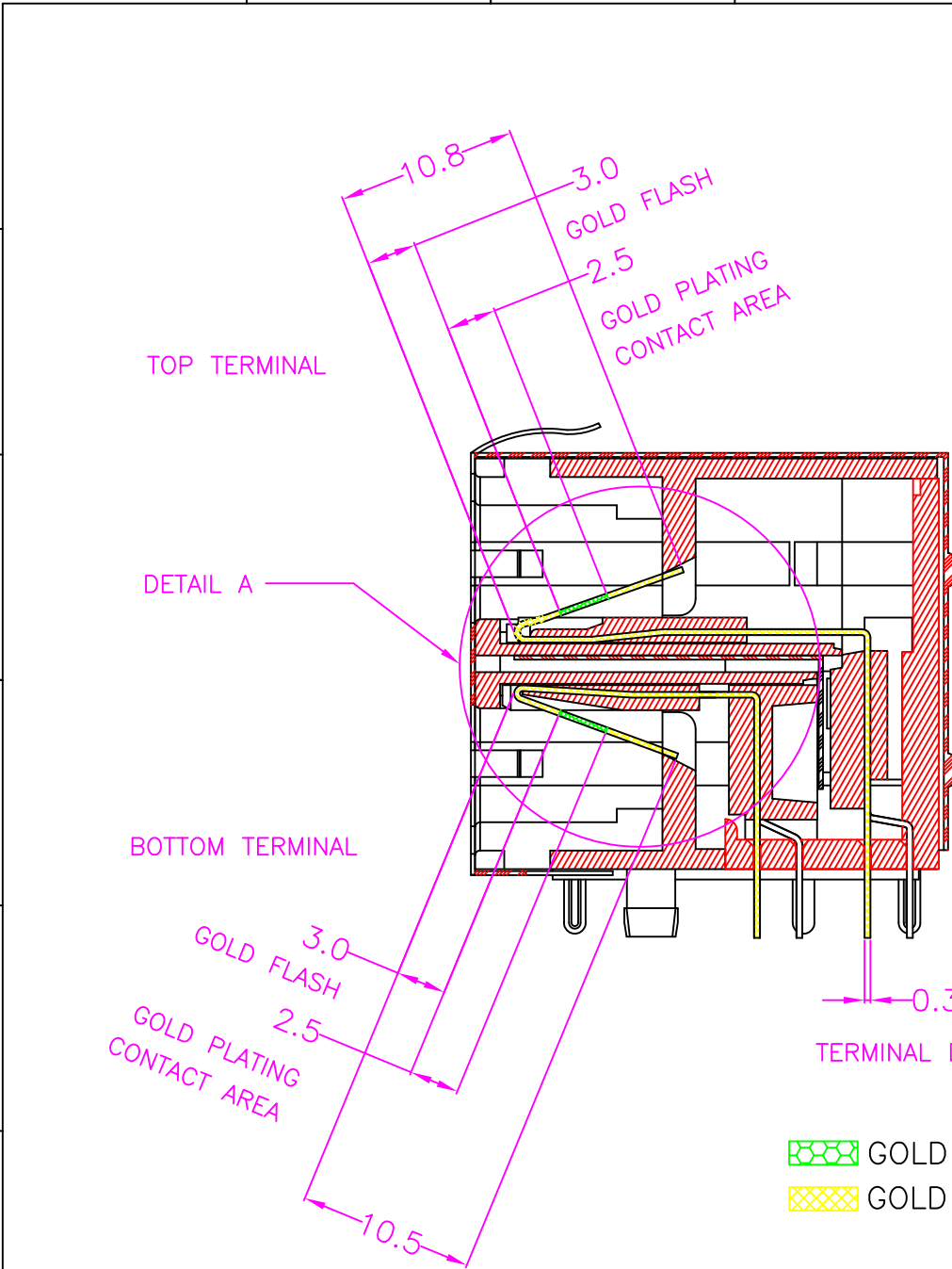
CURRENT RATING: 1.5 AMP MAX
DIELECTRIC WITHSTANDING: 500V AC FOR ONE MINUTE
CONTACT RESISTANCE: 30m OHMS MAX
INSULATION RESISTANCE: 1000M OHMS MIN AT DC 500V
OPERATION TEMPERATURE: -40°C~+85°C



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TOLERANCES		MODULAR JACK SERIES				
X.X ±0.3 X.XX ±0.2 X.XXX ±0.1 Angle ±5°		TITLE	2X6 STACKED RJ45, PCB MOUNT, SIDE ENTRY METAL SHIELD, WITH SPRING			
		DRAWN BY	CHECKED BY		APPROVED BY	
		Tina	Lion		Benson	
		UNIT	SCALE	SIZE	DRAW NO.	REV. Sheet
		10006&10058	MM	NONE	A4	3MJDD-006 A 1/2

INFORMATION

TERMINAL MATERIAL: COPPER ALLOY
TERMINAL DIMENSION: 0.35x0.46
TERMINAL FINISH: 30u" Min. GOLD PLATED ON CONTACT AREA
GOLD FLASH (1u") MIN. ON SOLDER TAIL
UNDERPLATED 50u" MIN. NICKEL



DETAIL A
SCALE 1 : 1.5

A	RELEASE	2014.12.2
REV.	DESCRIPTION	DATE

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TOLERANCES		TITLE					
X.X ±0.3		MODULAR JACK SERIES RJ45, TERMINAL DESCRIPTION					
X.XX ±0.2							
X.XXX ±0.1							
Angle ±5°							
		DRAWN BY		CHECKED BY		APPROVED BY	
		Tina		Lion		Benson	
10006&10058	UNIT	SCALE	SIZE	DRAW NO.	REV.	Sheet	
	MM	NONE	A4	3MJDD-006	A	1/1	